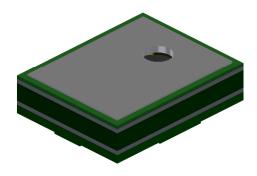
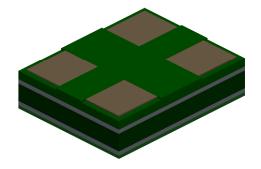


Amplified "Mini" SiSonic™ Microphone Specification With Enhanced RF Protection-Halogen Free





Knowles Acoustics 1151 Maplewood Drive Itasca, IL 60143





1. DESCRIPTION AND APPLICATION

1.1 DESCRIPTION

Amplified "Mini" Surface Mount Silicon Microphone with Enhanced RF Protection.

1.2 APPLICATION

Hand held telecomunication devices.

2. PART MARKING

Identification Number Convention

S 1 2 3

4 5 6 7

S: Manufacturing Location "S" - Knowles Electronics Suzhou Suzhou, China

> "No Alpha Character" - Knowles Electronics Itasca, IL USA

"E" - Engineering Samples

Digits 1-7: Job Identification Number

3. TEMPERATURE RANGE

- 3.1 Operating Temperature Range: -40°C to +100°C
- 3.2 Storage Temperature Range: -40°C to +100°C



Sheet 2 of 10



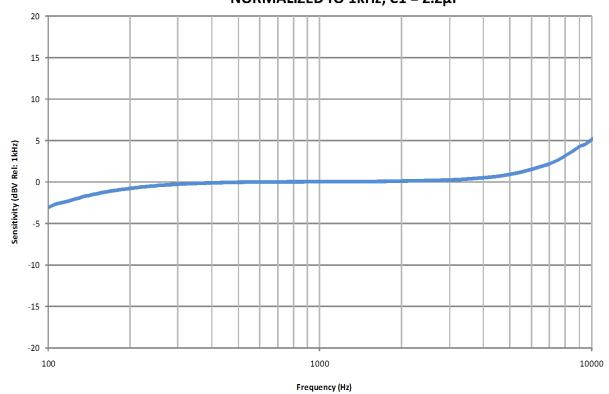
4. ACOUSTIC & ELECTRICAL SPECIFICATIONS

TEST CONDITIONS: +20°C, 60-70% R.H.

| | Symbol | Condition | | Limits | | Unit |
|---------------------------------|------------------|-------------------------|-----------------|------------|---------|---------|
| | Зуптьог | Condition | Min. | Nom. | Max. | Offili |
| Directivity | | Omni-directional | | - | | |
| Sensitivity | S | @ 1kHz (0dB-1V/Pa) | -26 | -22 | -18 | dB |
| Output Impedance | Zout | @ 1kHz (0dB-1V/Pa) | | _ | 300 | Ω |
| Current Consumption | l _{DDs} | Across 1.5 to 3.6 volts | 100 | _ | 350 | μA |
| Signal to Noise Ratio | S/N | @ 1kHz (0dB-1V/Pa) | 55 | 59 | - | dB |
| Supply Voltage | Vs | | 1.5 | | 3.6 | V |
| Typical Input Referred Noise | ENL | A-weighted | | 35 | | dBA SPL |
| Sensitivity Loss Across | | Change in sensitivity | No Char | ige Across | Voltage | dB |
| Voltage | | over 3.6V to 1.5V | | Range | | ав |
| Maximum Input Sound | | At 100dB | 3 SPL, THD < 1% | | | |
| Level | | At 115dB S | SPL, THD ≤ 10% | | | |

5. FREQUENCY RESPONSE CURVE

Typical Free Field Response NORMALIZED TO 1kHz, C1 = 2.2μF



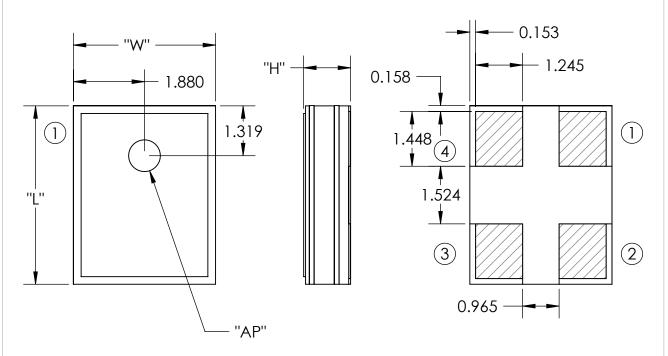


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Revision: B Release Level: ACTIVE Sheet 3 of 10



6. MECHANICAL SPECIFICATIONS



| ITEM | DIMENSION | TOLERANCE | UNITS |
|------------|-----------|-----------|-------|
| LENGTH (L) | 4.720 | ±0.100 | mm |
| WIDTH (W) | 3.760 | ±0.100 | mm |
| HEIGHT (H) | 1.250 | ±0.100 | mm |
| ACOUSTIC | Ø0.838 | ±0.100 | no no |
| PORT (AP) | Ø0.030 | ±0.100 | l mm |

| PIN OUTPUT | | |
|------------|-------------|--|
| PIN # | FUNCTION | |
| 1 | OUTPUT | |
| 2 | GAIN | |
| 3 | GROUND | |
| 4 | POWER (Vdd) | |

Note:

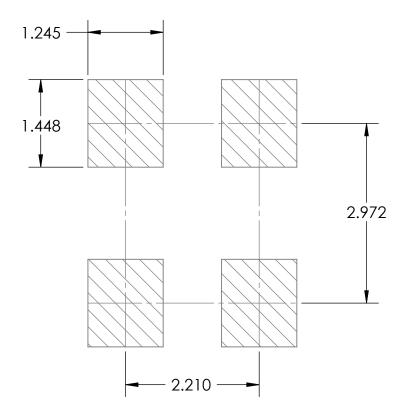
Dimensions are in milimeters unless otherwise specified.

Tolerance ± 0.15 mm unless otherwise specified.





7. RECOMMENDED CUSTOMER LAND PATTERN



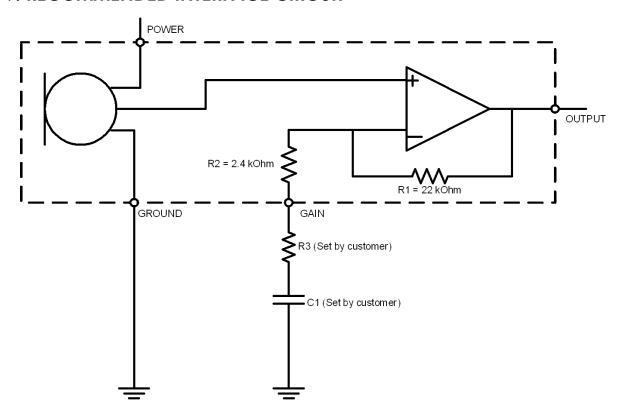
8. RECOMMENDED SOLDER STENCIL PATTERN

N/A





9. RECOMMENDED INTERFACE CIRCUIT



| DESIRED GAIN | GAIN PIN TERMINATION METHOD |
|------------------|--|
| Unity Gain (0dB) | Tie Gain Pin directly to Output Pin |
| 20dB Gain | Tie Gain Pin through C1 (0.47µF) to Ground |
| | Add Ground Pin and C1. Use formulas provided to |
| Adjustable Gain | calculate settings of contact Knowles for support. |
| | |

Setting Gain Formulas:

Gain on non-inverting Op-Amp is determined as:

$$-> G = 1 + \{R1 / (R2 + R3)\}$$

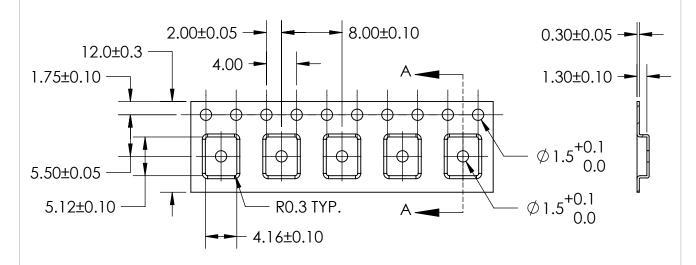
Gain(dB) - 20 * log(G)

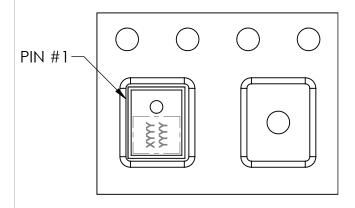
High-pass-filter Corner Frequency:





10. PACKAGING DETAIL





COMPONENT **ORIENTATION**

| MODEL NUMBER | SUFFIX | REEL | QUANTITY |
|------------------|--------|----------|----------|
| MODEL NOMBER | 30111X | DIAMETER | PER REEL |
| SPM0408HE5H | -2 | 7'' | 1,200 |
| 31 7/1040011L311 | -6 | 13" | 4,800 |

| TAPE & REEL | PER EIA-481 |
|-------------|---|
| II ABFI | LABEL APPLIED TO EXTERNAL PACKAGE & DIRECT TO REEL. |

Note:

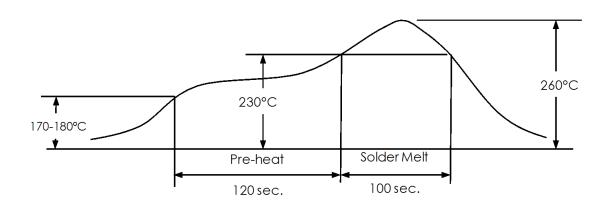
Dimensions are in milimeters unless otherwise specified.



Revision: B Release Level: ACTIVE Sheet 7 of 10



11. SOLDER FLOW PROFILE



| Stage | Temperature Profile | Time (maximim) |
|-------------|---------------------|----------------|
| Pre-heat | 170 ~ 180°C | 120 sec. |
| Solder Melt | Above 230°C | 100 sec. |
| Peak | 260°C maximum | 30 sec. |

12. ADDITIONAL NOTES

- (A) Shelf life: Twelve (12) months when devices are to be stored in factory supplied, unopened ESD moisture sensitive bag under maximum environmental conditions of 30°C, 70% R.H. MSL (moisture sensitivity level) Class 2a.
- (B) Do not pull a vacuum over port hole of the microphone. Pulling a vacum over the port hole can damage the device.
- (C) Do not board wash after the reflow process. Board washing and cleaning agents can damage the device. Do not expose to ultrasonic processing or cleaning.
- (D) Do not brush board after the reflow process. Brushing the board with/without solvents can damage the device.
- (E) <u>Do not insert any object in port hole</u> of device at any time as this can damage the device.
- (F) Number of reflow Recommend no more than 3 cycles.



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Release Level: ACTIVE Sheet 8 of 10

Revision: B



13. RELIABILITY SPECIFICATIONS

Note: After test conditions are performed, the sensitivity of the microphone shall not deviate more than 3dB from its initial value.

| Test | Description |
|-------------------------|---|
| Thermal Shock | 100 cycles of air-air thermal shock from -40°C to |
| momal one or | +125°C with 15 minute soaks. (ICE 68-2-4) |
| High Temperature | +105°C environment for 1,000 hours. (ICE 68-2-2 Test |
| Storage | Ba) |
| Low Temperature | -40°C environment for 1,000 hours. (ICE 68-2-2 Test Aa) |
| Storage | -40 C environment for 1,000 hoors. (ICL 60-2-2 lest Ad) |
| High Temperature Bias | +105°C environment while under bias for 1,000 hours. |
| Inigh temperature bias | (ICE 68-2-2 Test Ba) |
| Low Tomporature Pias | -40°C environment while under bias for 1,000 hours. |
| Low Temperature Bias | (ICE 68-2-2 Test Aa) |
| Temperature / Humidity | +85°C/85% R.H. environment while under bias for 1,000 |
| Bias | hours. (JESD22-A101A-B) |
| | 4 cycles lasting 12 minutes from 20 TO 2,000 Hz in X, Y |
| Vibration | and Z direction with peak acceleration of 20g. (MIL |
| | 883E, Method 2007.2, A) |
| | 3 discharges at +/-8kV direct contact to lid when unit |
| Electrostatic Discharge | is grounded (IEC 61000-4-2) and 3 discharges at +/-2kV |
| | direct contact to I/O pins. (MIL 883E, Method 3015.7) |
| | |
| Reflow | 5 reflow cycles with peak temperature of +260°C. |
| Mechanical Shock | 3 pulses of 10,000g in the X, Y and Z direction. (IEC 68-2- |
| THOUSE GROUND | 27, Test Ea) |





14. SPECIFICATION REVISIONS

| Revision | Detailed Specification Changes | Date | |
|----------|---|-----------|--|
| Α | Specification Release (DMS) | 8/14/2009 | |
| В | Update sensitivity spec (section 4). (DMS, C10110154) | 9/1/2009 | |
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